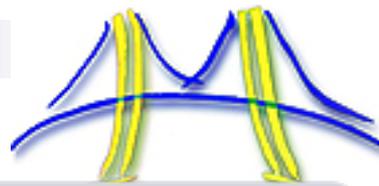


Performance and Energy Comparison of Electrical and Hybrid Photonic Networks for CMPs

Ankit Jain, Shoaib Kamil, Marghoob Mohiyuddin, John Shalf,
John Kubiatowicz

UC Berkeley ParLab/LBNL



Introduction

- Motivation
- Contributions
- Baseline Architecture

Electrical Network

- Architecture
- Simulator
- Model

Hybrid Network

- Architecture
- Simulator
- Model

Studied Communications

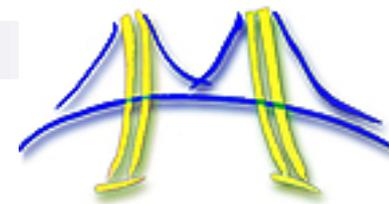
- Synthetic Communication
- Real Applications

Results

- Synthetic Results
- Application Results
- Process to Processor Mapping

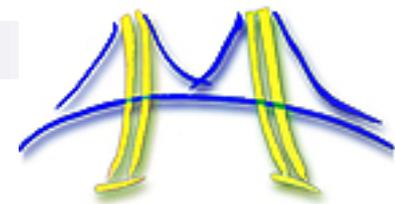
Conclusions and Future Work

Motivation



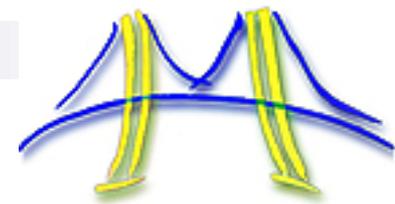
- Manycore: NoCs key to translating raw performance → sustained performance
- Electrical NoC performance/energy constrained by process technology
 - Also, every joule saved counts
- Photonic NoC promising
 - Enabled by recent advances in photonics & chip fabrication
 - Potentially high performance at low energy cost
 - But cannot do packet switching
- Use hybrid network
 - Small packets → electrical NoC
 - Large packets → optical NoC

Contributions

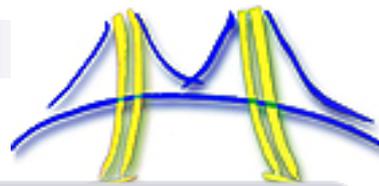


- Use both synthetic traces and real application traces to compare electrical vs. hybrid photonic networks
- Construct cycle-accurate simulators and compare with simple analytic models
- Programmability: How important is process-to-processor mapping?

Baseline Architecture



- 64 small, homogenous cores on a CMP
- Cores $\sim 1.5\text{mm} \times 1.5\text{mm}$
- 22nm process, 5GHz
- 3D Integrated CMOS
 - layer for processors, layers for memory
- We examine two interconnect architectures to compare performance & energy efficiency



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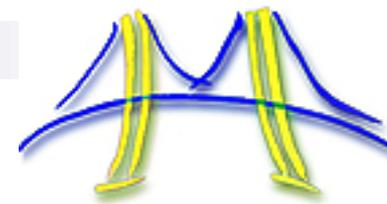
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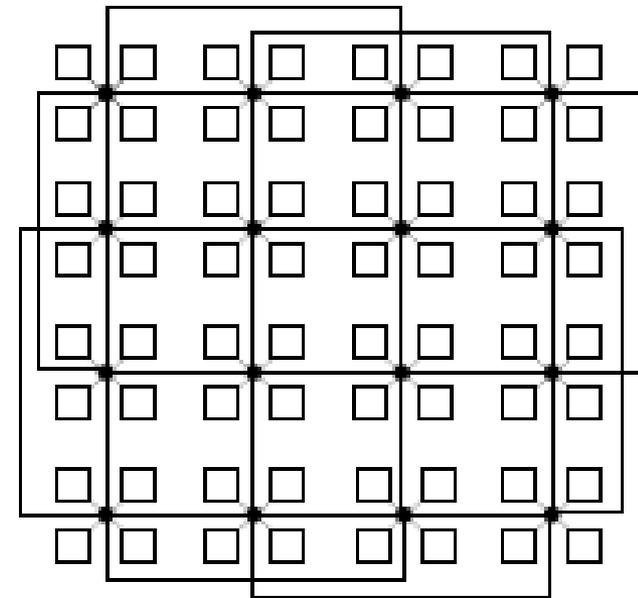
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Electrical NoC

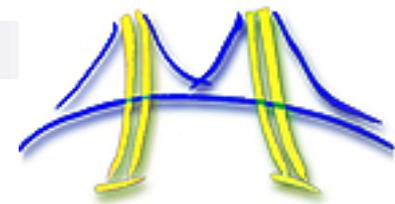


- Bill Dally's CMesh topology
- Wormhole routed
- Virtual channels
- Single electrical layer with multiple memory layers



(b) CMesh

Electrical Simulator



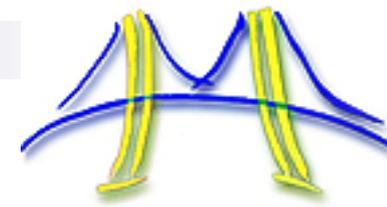
■ Processor

- Ignore computation
- Communication divided into “phases” (SPMD-style)
 - Send and receive all messages in a phase as fast as possible

■ Router

- XY dimension order routing
- Express links on periphery
- Virtual channels & wormhole routing
- Credit based flow control
- 8 input ports → 8x8 switch

Analytic Model for Electrical NoC



■ Time

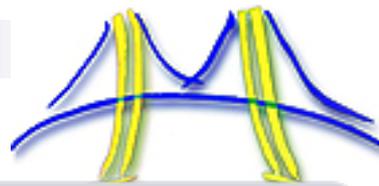
- Bandwidth-only model
- Assume virtual channels + wormhole routing hide latency

$$T_{msg} = \frac{size_{msg}}{bandwidth}$$

■ Energy

- Each hop incurs a set amount of energy
- Link crossing + Router traversal
- Parameters from Dally et al, scaled via ITRS

$$E_{total} = \sum (|L_{msg}| \times E_{hop})$$



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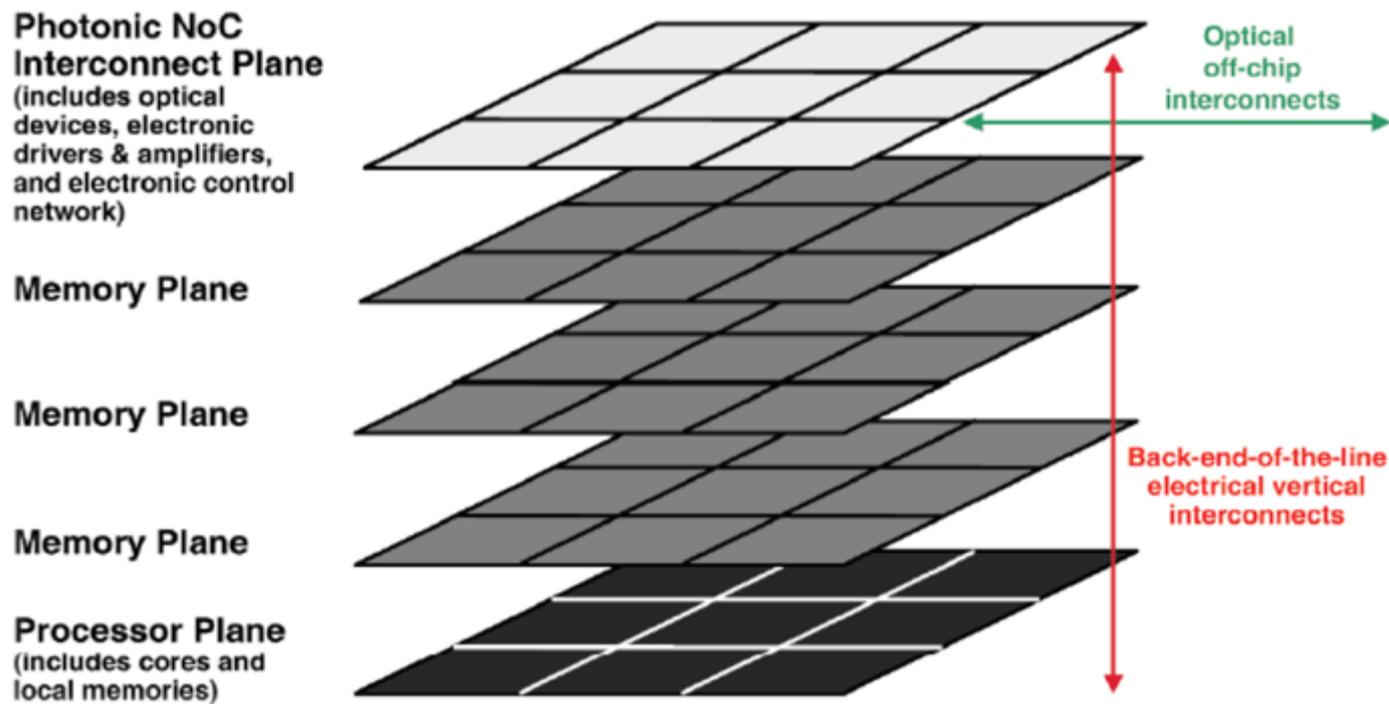
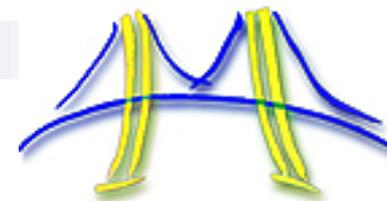
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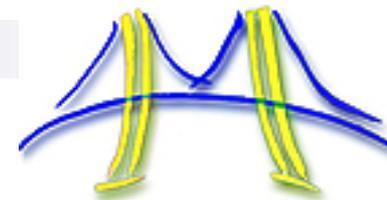
Conclusions and Future Work

Hybrid NoC

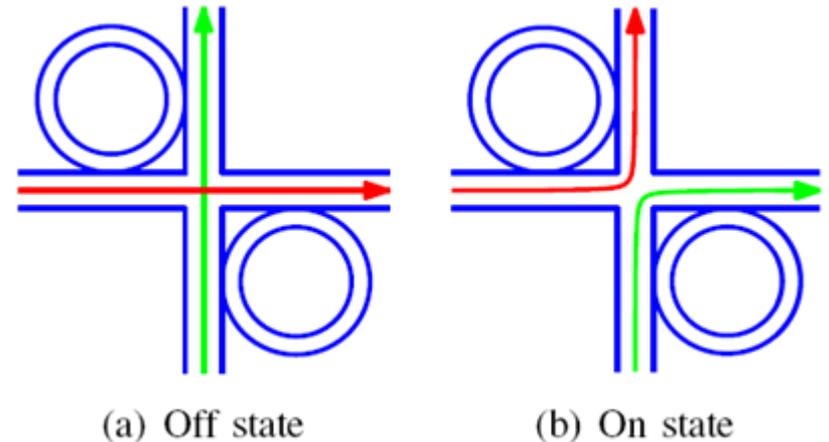
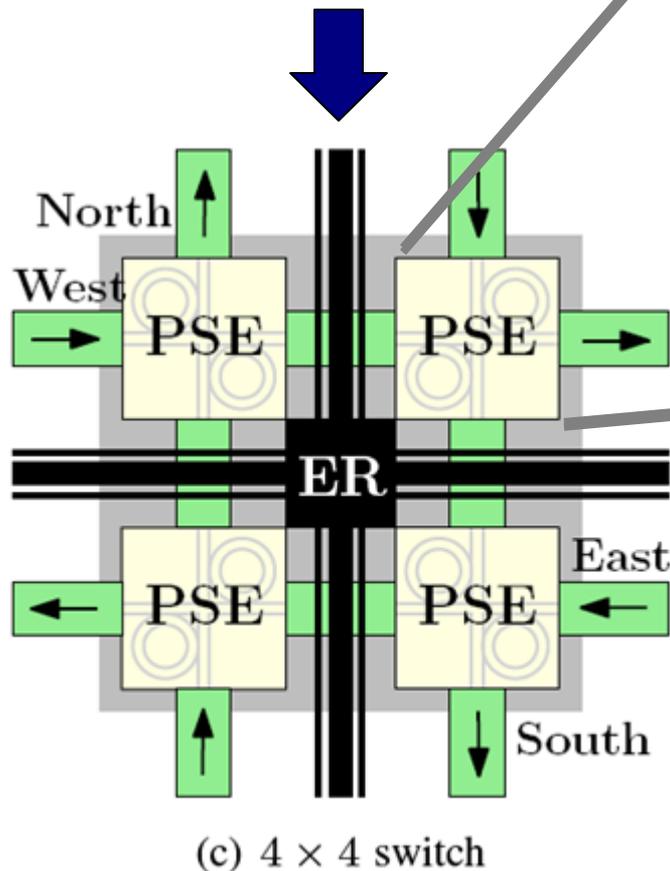


- Mesh Topology
- “Electrical Control Network” (ECN) on Processor Plane
- Multiple optical networks on Photonic Plane
- Small setup messages on ECN and bulk data transfer on optical network

Blocking Photonic Switch

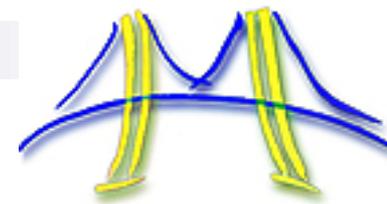


Capable of routing a single path from any source to any destination



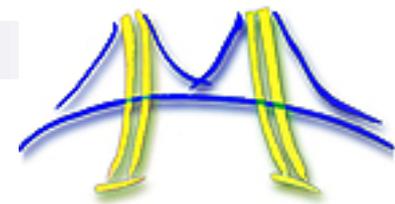
- On \rightarrow message turns
- No inactive power consumption
- Small switching cost
- Small active power while switched on

Deadlock in Hybrid NoC



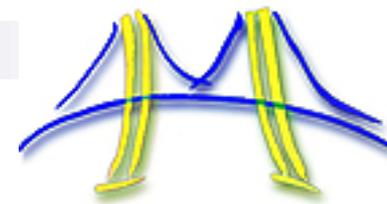
- Blocking 4x4 switch
 - Only one path can be routed at a time through a switch
- Deadlock is a known issue in circuit switching. Avoid deadlock with:
 - Exponential backoff
 - Dimension order routing
 - Multiple optical networks
 - Results in more possible paths
 - Since photonic elements are quite small, this is doable

Hybrid Simulator



- 1:1 processor to electrical router mapping
 - Each electrical router buffers up to 8 path setup messages from its corresponding processor
 - Electrical router does not use virtual channels or wormhole routing (unnecessary and consume energy)
- Path setup packets are minimally sized: take one cycle to traverse between 2 routers
- Energy includes Electro-Opto-Electrical conversions at the endpoints
 - Most expensive operation energy-wise
 - Did not include off-chip laser energy cost

Analytic Model for Hybrid NoC



■ Time

- Must account for latency of electrical network, bandwidth limits, and contention

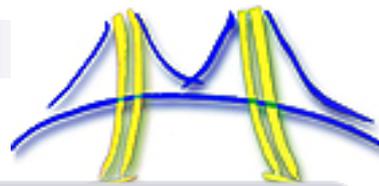
$$T_{msg} = |L_{msg}| \times 2 \times latency_{electrical} + \frac{size_{msg}}{bandwidth_{optical}}$$

- For contention, serialize “most-used” link
 - Only one message can be sent along link at a time
 - Overall time is time to send all messages on busiest link

■ Energy

- Each message incurs energy cost on electrical network, plus the costs on the photonic network

$$E_{total} = \sum (|L_{msg}| \times E_{electrical} + E_{PSEswitching} + T_{msg} \times E_{PSEactive} + E_{EOE} \times size_{msg})$$



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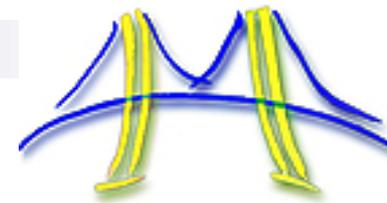
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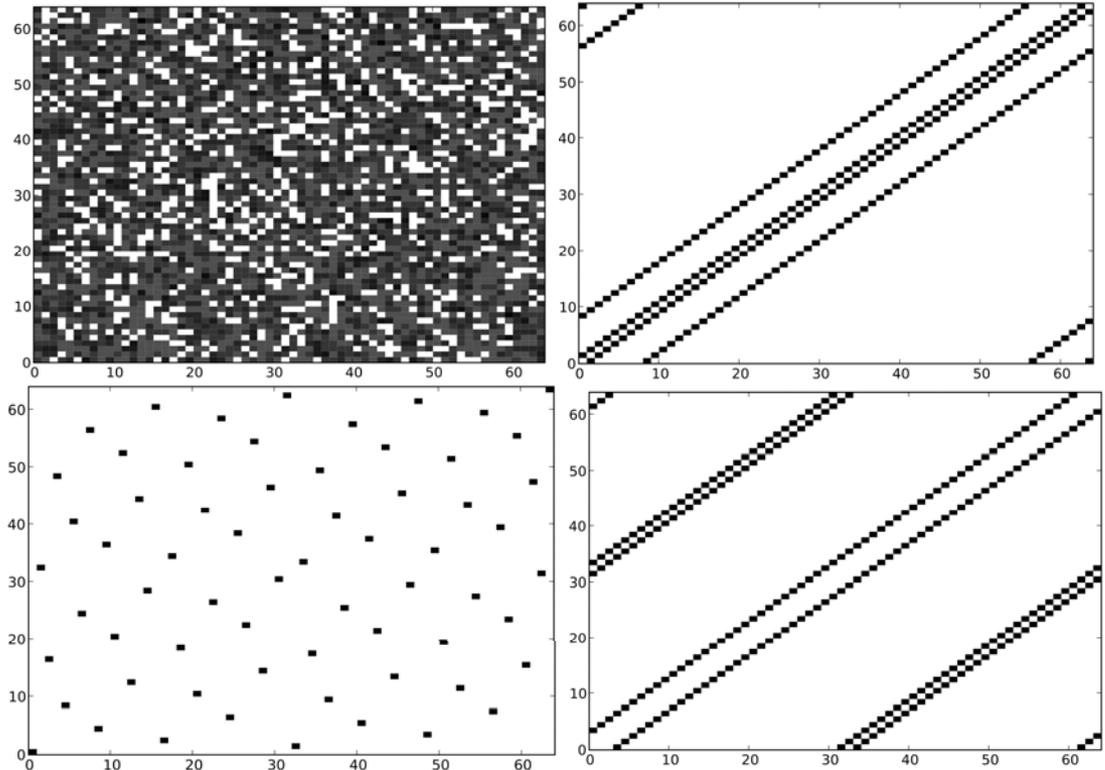
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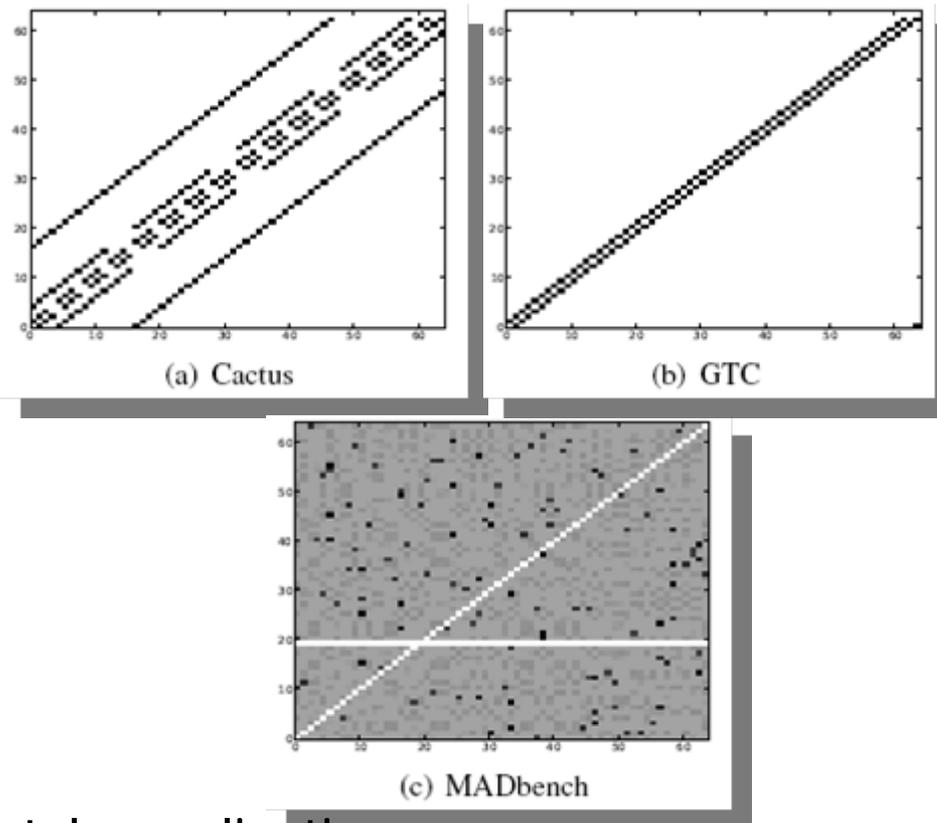
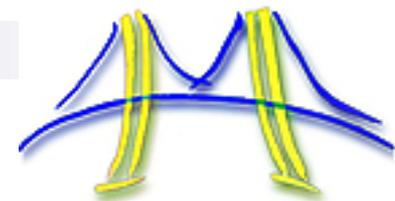
Synthetic Traces



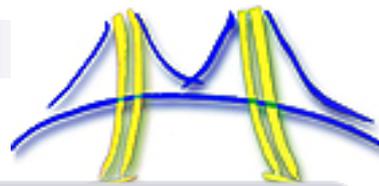
- Random messages
- Nearest-Neighbor
- Bitreverse
- Tornado
- Look at both small & large messages



Real Applications



- SPMD style applications
- From DOE/NERSC workloads
- Broken into multiple phases of communication
 - implicit barrier is assumed at the end of a communication phase



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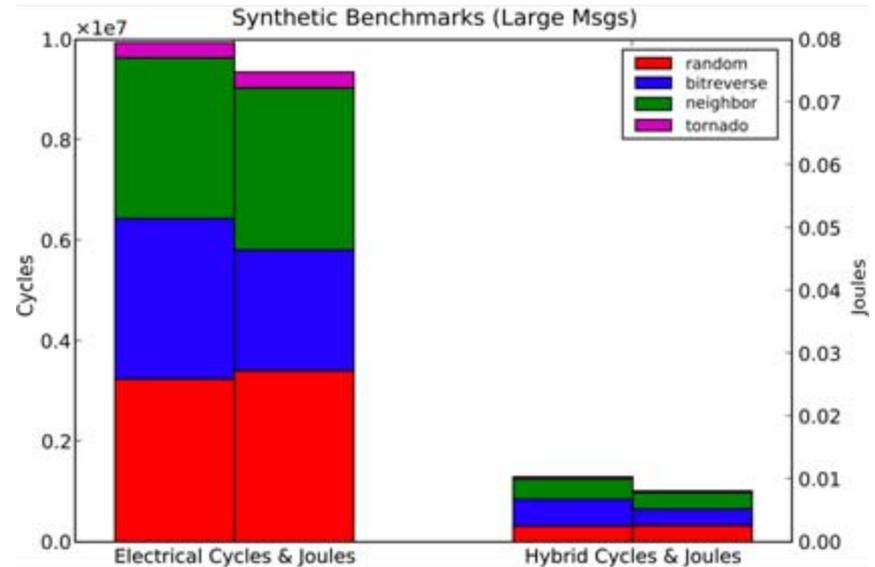
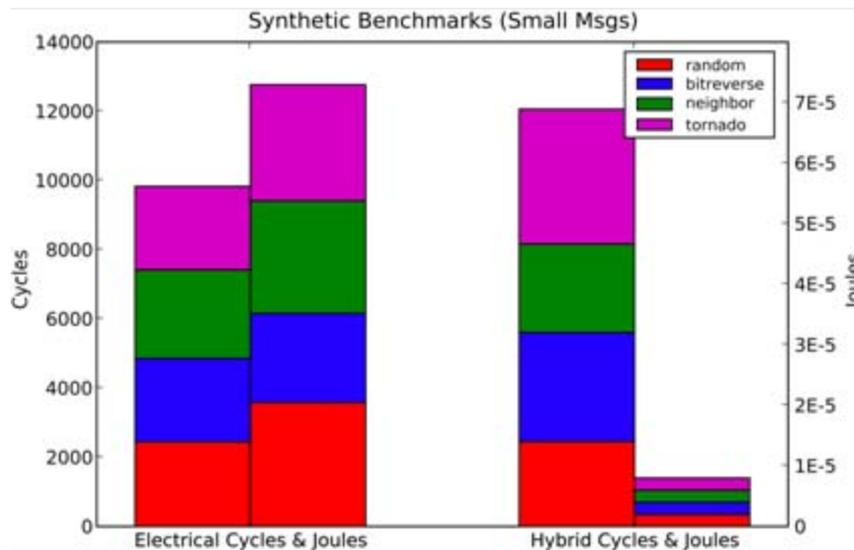
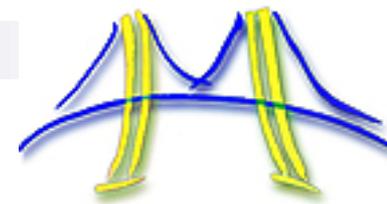
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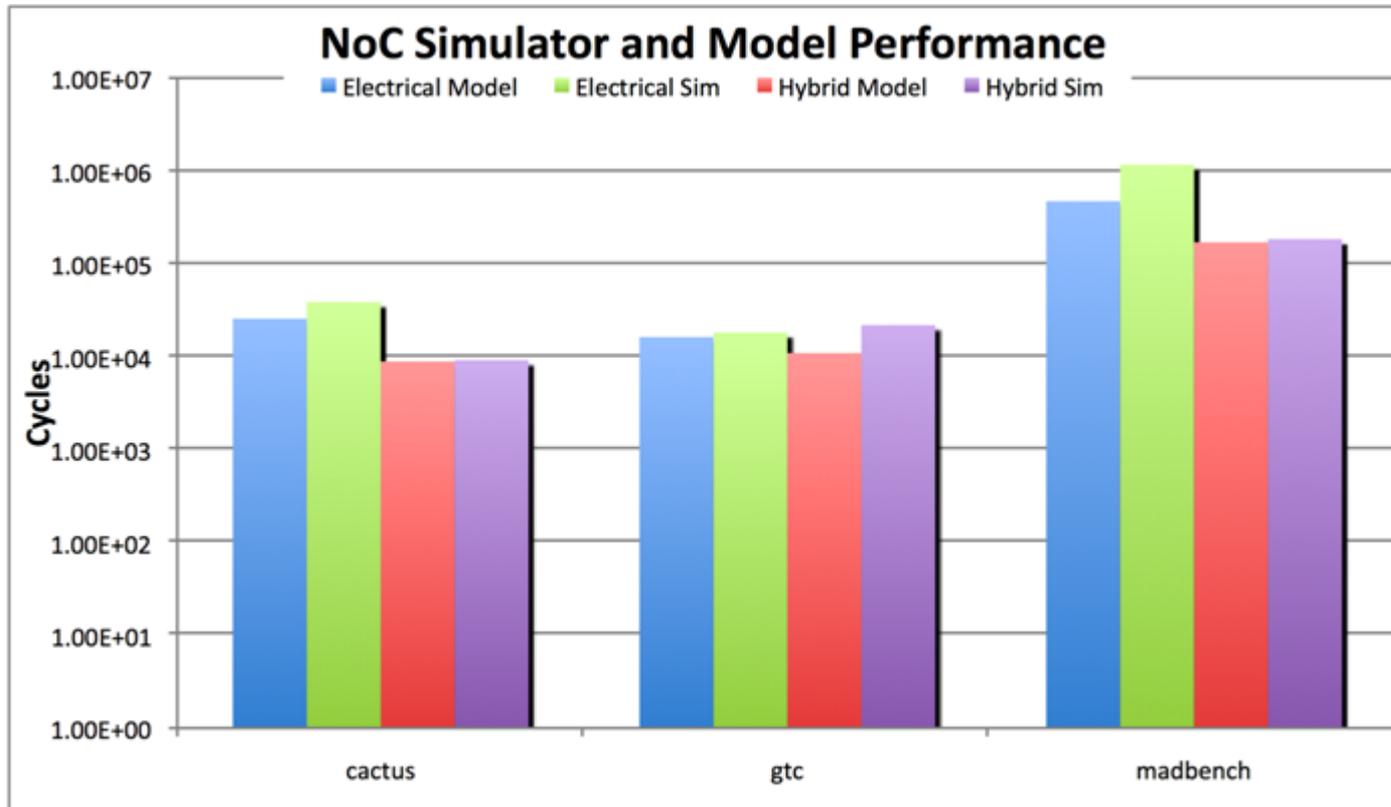
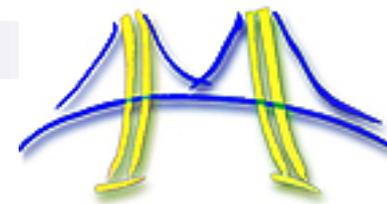
Conclusions and Future Work

Synthetic Trace Results

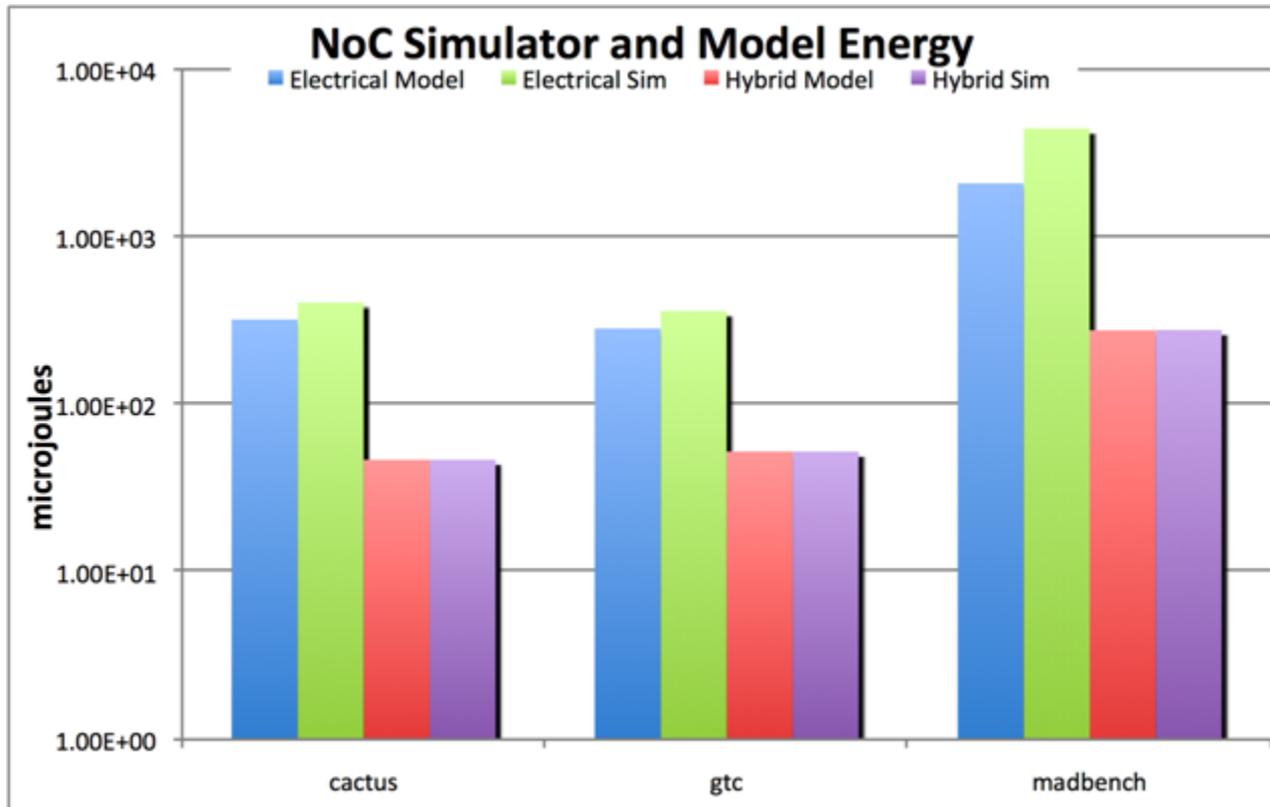
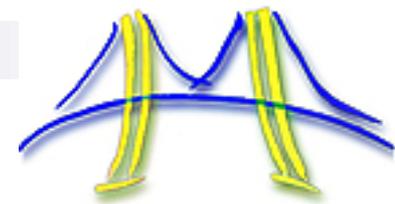


- For small messages, setup latency for the hybrid network makes it slower than electrical
- Hybrid network outperforms electrical-only on large messages, and uses far less energy in both cases

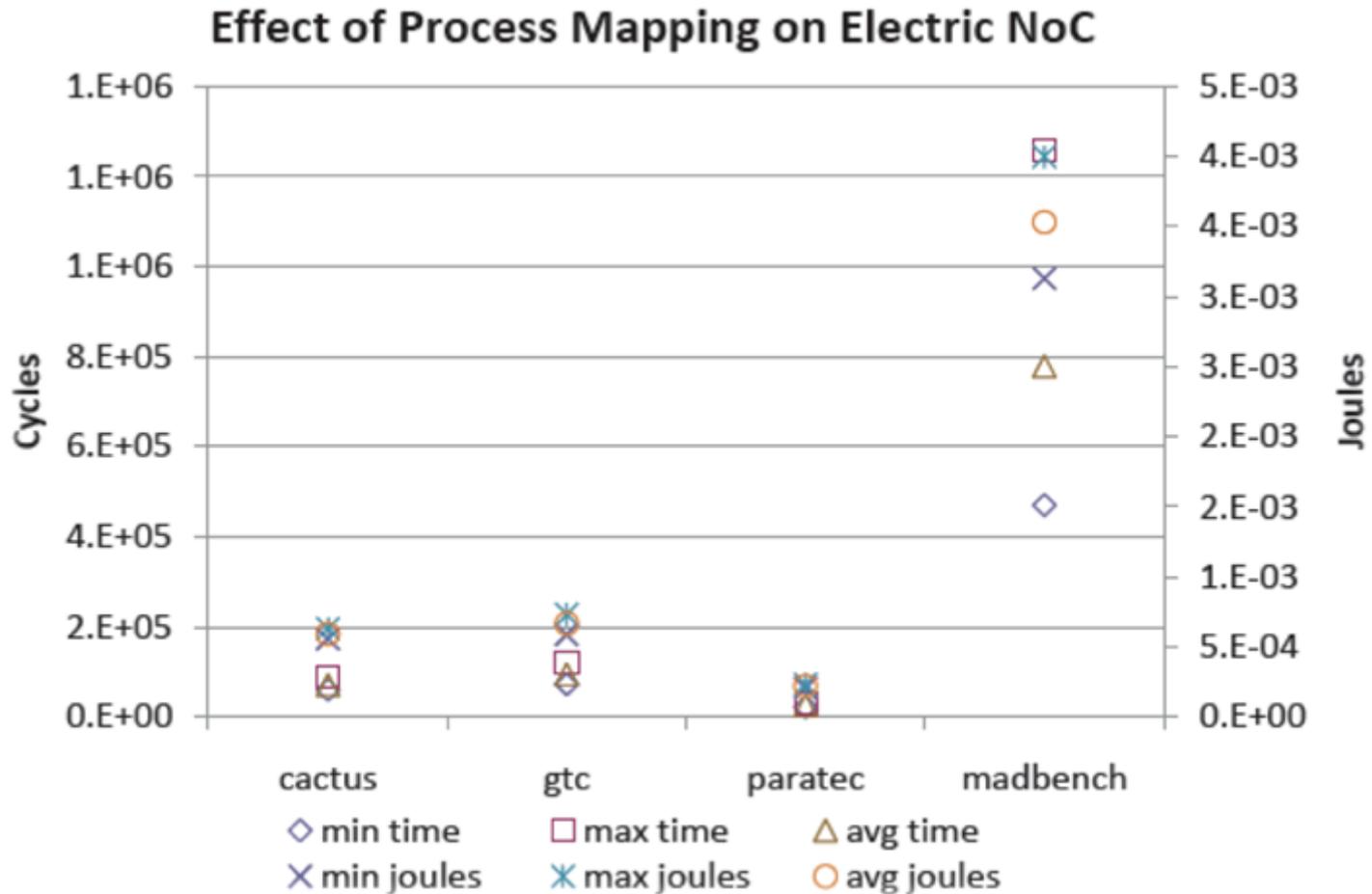
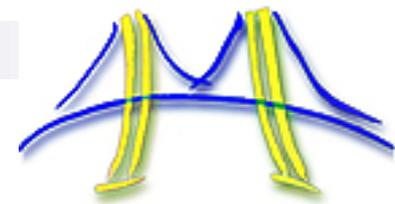
Application Performance



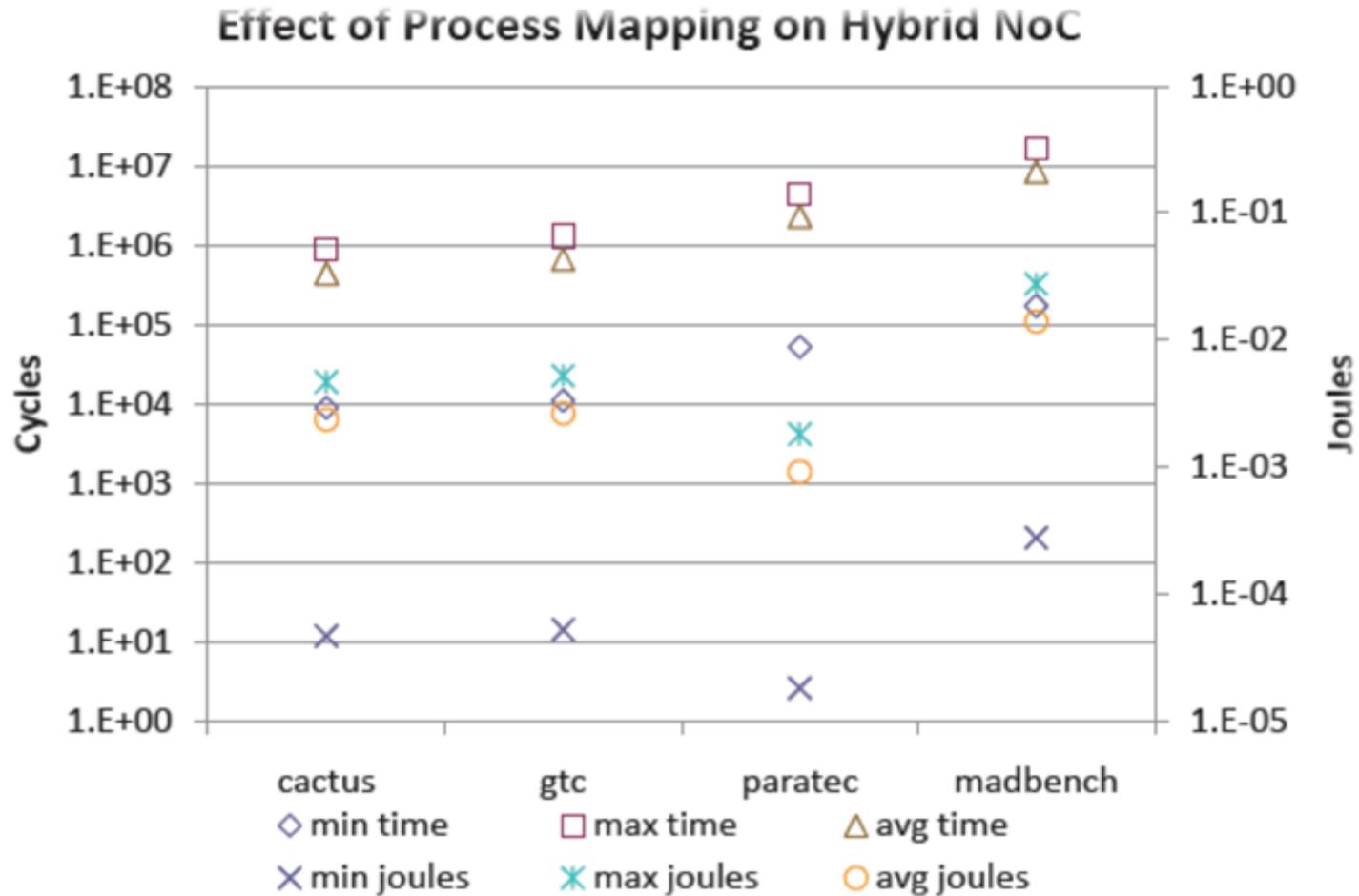
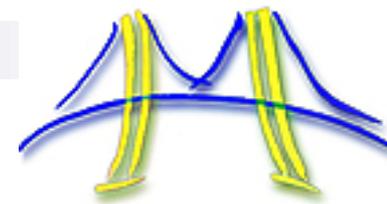
Application Energy

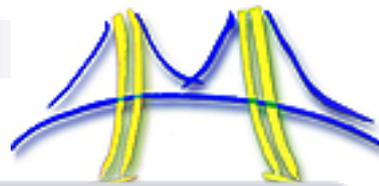


Process-Processor Mapping (1/2)



Process-Processor Mapping (2/2)





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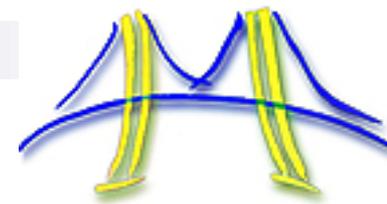
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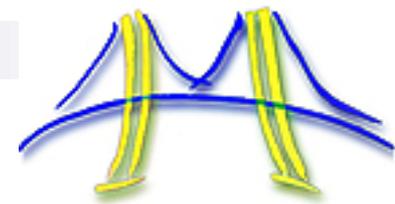
Conclusions and Future Work

Conclusions



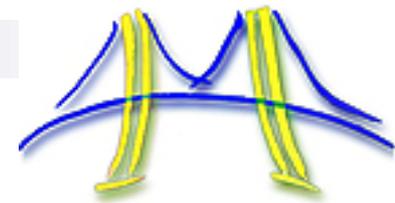
- Simple analytic models accurately predict both performance and energy consumption
- Hybrid NoC: Majority of energy due to Optical-to-Electrical and Electrical-to-Optical conv. (>94%).
- Hybrid NoC performs better for larger messages; energy consumption is much lower
- Process-to-processor mapping can significantly impact performance as well as energy consumption.
 - Finding the optimal mapping is not always of utmost importance— making sure not to use a 'bad' mapping is.
- Overall, hybrid photonic on-chip networks are promising

Future Work



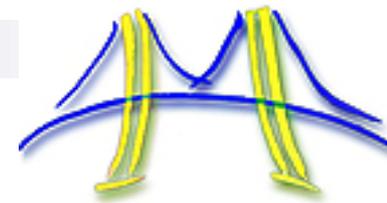
- Non-blocking optical mesh interconnection network
- Account for data transfer onto chip
- More accurate full system simulators (for both performance and energy)
 - simulate FP operations & memory traffic
 - as photonic technologies are explored by materials/hardware designers, use input to revise/refine simulators
- Explore applications with less synchronous communication models
 - Not SPMD
 - Overlap of computation and communication

Acknowledgements

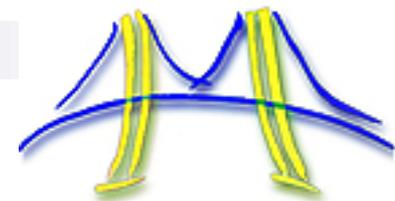


- Katherine Yelick (UC Berkeley ParLab & NERSC/LBNL)
- Assam Schacham, Luca Carloni and Dr. Keren Bergman (Columbia University)
 - Our exploration is based on their earlier work (see references)
- BeBOP Research Group (UC Berkeley Computer Science Dept)

References

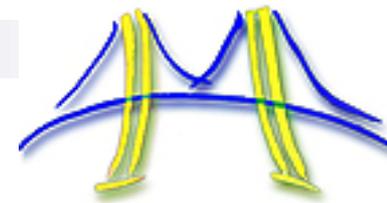


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Backup Slides

Analytic Model



■ Three Models

□ Bandwidth Model

- For electrical network: assume virtual channels hide latency

□ Bandwidth + Latency Model

□ Bandwidth + Latency + Contention Model

ELECTRICAL

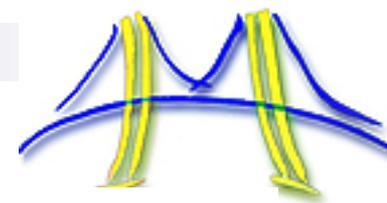
HYBRID

$$T_{msg} = \frac{size_{msg}}{bandwidth}$$

$$T_{msg} = |L_{msg}| \times 2 \times latency_{electrical} + \frac{size_{msg}}{bandwidth_{optical}}$$

$$E_{total} = \sum (|L_{msg}| \times E_{hop})$$

$$E_{total} = \sum (|L_{msg}| \times E_{electrical} + E_{PSEswitching} + T_{msg} \times E_{PSEactive} + E_{EOE} \times size_{msg})$$



Silicon Photonics Today

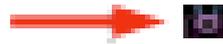
Needed for on-chip

Ring modulator

Radius 30 μ m



Area 25X
Power 10X



Radius 6 μ m

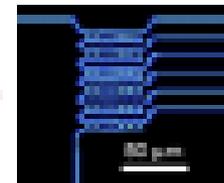
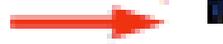
WDM filters

1.4mmx0.6mm=0.85mm²

Add. power for tuning



Area 150X
No active tuning
Thermally stable



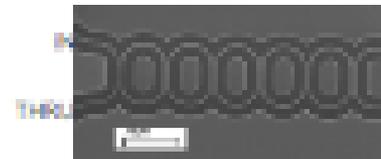
50x100 μ m=0.005mm²
No active feedback,
accuracy is defined by
fabrication

Deflection Switch

Macroscopic



Nanoscale
No active tuning
Thermally stable

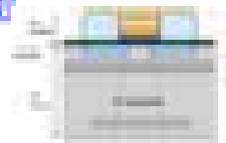


30^o temp range

On-chip optical amplifier

Macroscopic

Not integrated

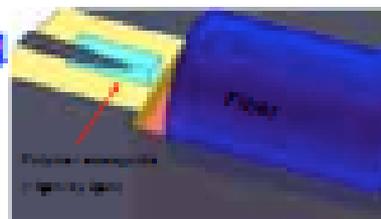


Mass manufacturable III-V on Si
(~50/chip)
Wafer scale

Optical Coupling

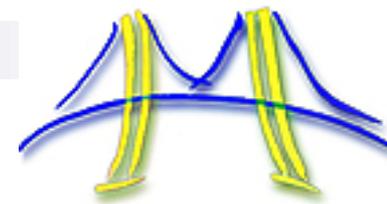
Hand-aligned

Low numbers



Mass manufacturable alignment (~50
fibers)
Package in presence of C4s and
heatsink

Electrical Simulator (2/2)



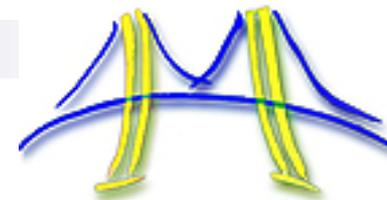
■ Channels

- Buffering at both ends
- Maximum wire length = side of processor core

ELECTRICAL SIMULATOR PARAMETERS

Model Parameter	Sim Parameter	Value
$latency_{electrical}$	Router Latency	2 cycles
	Router-Router Link Latency	2 cycles
	Virtual channels	1,2,4,6
	Buffer size in flits	1,2,3,4
	Frequency	5 GHz
$bandwidth_{electrical}$	Electrical Bandwidth	640 Gb/sec
$E_{electrical}$	Joules Per Electrical Hop	0.82e-12

Hybrid Simulator (2/2)



HYBRID SIMULATOR PARAMETERS

Model Parameter	Sim Parameter	Value
<i>latency_{electrical}</i>	Router Latency	2 cycles
	Router-Router Link Latency	1 cycle
	Path Multiplicity	1,2,4
	Time To Timeout	2,10,20
	Frequency	5 GHz
<i>bandwidth_{optical}</i>	Optical Bandwidth	960 Gb/sec
<i>E_{PSEswitching}</i>	Joules Per PSE Switching	1.0e-12
<i>E_{PSEActive}</i>	Joules Per PSE on Per Second	1.0e-6
<i>E_{electrical}</i>	Joules Per Electrical Hop	0.82e-12
<i>E_{EOE}</i>	Joules Per Bit EOE ¹	0.4e-12

Parameter Exploration: Electrical NoC

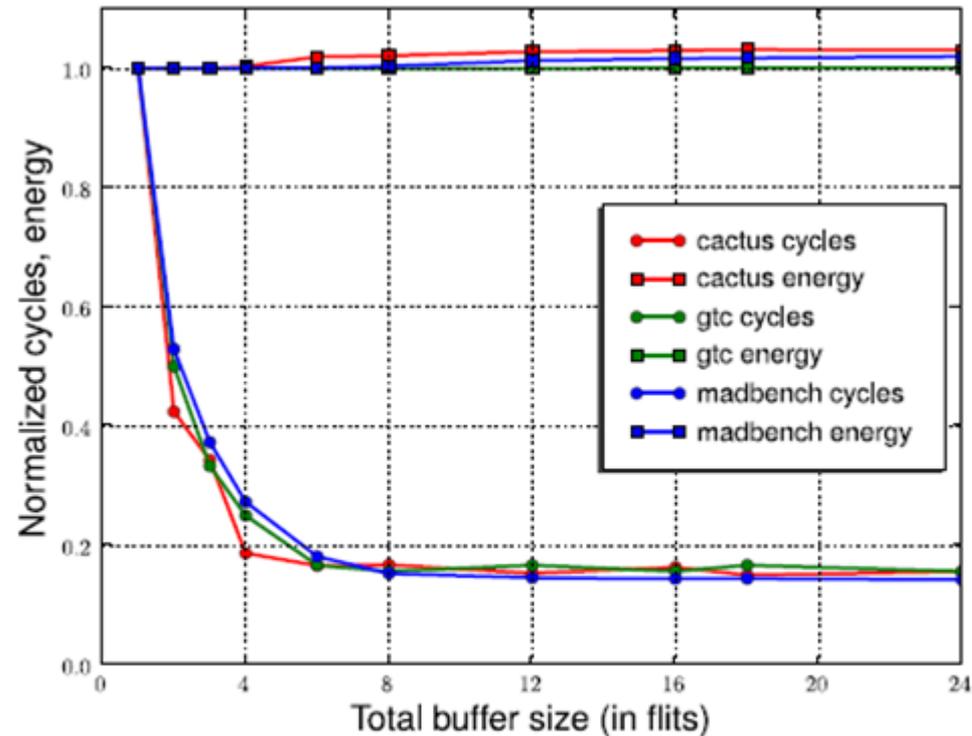
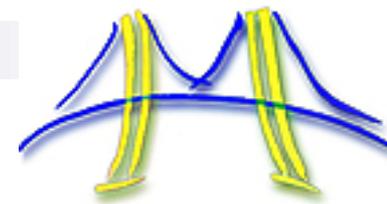
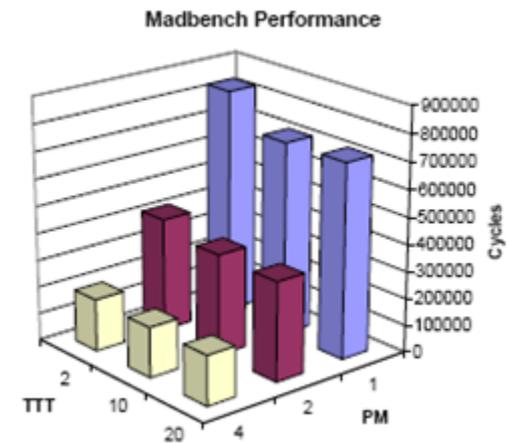
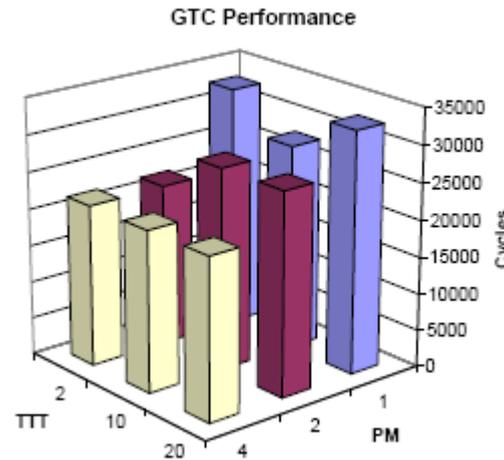
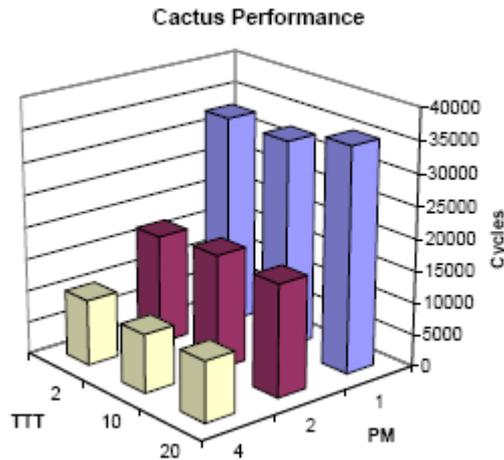
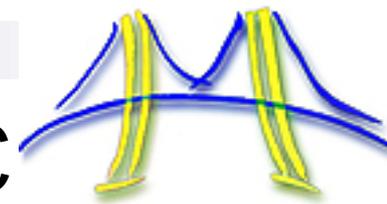


Fig. 5. Parameter exploration results for electrical NoC. Results are for communication phases only. The energy and cycle numbers are normalized w.r.t. total buffer size of 1 case (lower is better).

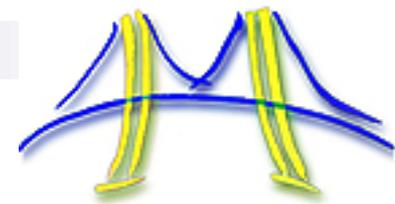
Total buffer size = #vcs X buffer size → router

Parameter Exploration: Hybrid NoC



- Sensitive to path multiplicity
 - more available paths = less contention
- Timeouts prevent over- and under-waiting

NoC as Part of a System



- Use Merrimac FP unit numbers
- Scale to 22nm using ITRS roadmap
- Trace methodology records FP Operations
- Compare energy used in FP unit vs energy used in interconnect

